

L Number	Hits	Search Text	DB	Time stamp
1	3	"61114563"	JPO; DERWENT	2004/02/08 14:25
2	2	"06177268"	JPO; DERWENT	2004/02/08 14:11
3	1	("5254500").PN.	USPAT	2004/02/08 14:11
4	1	("5483098").PN.	USPAT	2004/02/08 14:41
5	443	438/125.ccls. and (@ad<20000816)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/08 14:46
6	35	(438/125.ccls. and (@ad<20000816)) and ((laser\$3 or etch\$3 or polish\$3 or cmp) with (resin or mold\$3 or encapsula\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/08 14:46
7	315	438/122.ccls. and (@ad<20000816)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/08 15:11
8	12	(438/122.ccls. and (@ad<20000816)) and ((laser\$3 or etch\$3 or polish\$3 or cmp) with (resin or mold\$3 or encapsula\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/08 15:10
10	1	(438/For.413.ccls. and (@ad<20000816)) and ((laser\$3 or etch\$3 or polish\$3 or cmp) with (resin or mold\$3 or encapsula\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/08 14:49
9	228	438/For.413.ccls. and (@ad<20000816)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/08 14:49
11	0	58100447.URPN.	USPAT	2004/02/08 15:04
12	0	58100447.URPN.	USPAT	2004/02/08 15:04
13	41	(438/122.ccls. and (@ad<20000816)) and ((hole or opening) with (resin or mold\$3 or encapsula\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/08 15:09
14	615	((insert\$3 or attach\$3) with (sink or spreader or pipe)) and ((laser\$3 or etch\$3 or polish\$3 or cmp) with (resin or mold\$3 or encapsula\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/08 15:11
15	404	((insert\$3 or attach\$3) with (sink or spreader or pipe)) and ((laser\$3 or etch\$3 or polish\$3 or cmp) with (resin or mold\$3 or encapsula\$4))) and (@ad<20000816)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/08 15:12
16	106	((insert\$3 or attach\$3) with (sink or spreader or pipe)) and ((laser\$3 or etch\$3 or polish\$3 or cmp) with (resin or mold\$3 or encapsula\$4))) and (@ad<20000816)) and (chip or die) and (semiconductor or ic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/08 15:12